

## WIO SuperServer SYS-112B-WR

1U UP WIO with 10 hot-swap 2.5" NVMe/SAS/SATA bays and 3 PCIe 5.0 slots



## **Key Applications**

Virtualization, Networking Appliance, Cloud Computing, Data Center Optimized, Database/Storage, Storage Headnode, Entry GPU server, Web Cache, CDN, Video Streaming, Al Inference,

## **Key Features**

- WIO systems offer flexible I/O configurations in a cost-effective architecture to deliver truly optimized systems for specific enterprise requirements.;
- Single Intel® Xeon® 6 6700 series processor with E-cores;
- 8 DIMM slots supporting up to 1TB of memory (6700E series CPU).;
- Tool-less, Top-loading riser design support 3 PCIe 5.0 Expansion (2x FHFL +
- Native SATA drives supported, with option for up to 8 PCIe 5.0 NVMe drives or 10 SAS drives.;
- Trusted Platform Module (TPM) 2.0 onboard



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1U Rackmount		
Enclosure: 437 x 43 x 597mm (17.2" x 1.7" x 23.5")		
Package: 597 x 197 x 800mm (23.5" x 7.75" x 31.5")		
Single Socket E2 (LGA-4710)		
Intel® Xeon® 6700 series processors with E-cores		
Up to 144C/144T; Up to 108MB Cache		
Max GPU Count: Up to 2 single-width GPUs		
CPU-GPU Interconnect: PCIe 5.0 x16 CPU-to-GPU Interconnect		
Slot Count: 8 DIMM slots/8 Channels		
Max Memory (1DPC): Up to 1TB 6400MT/s ECC DDR5 RDIMM		
Default: Total 8 bays		
• 8 front hot-swap 2.5" SATA drive bays		
Option A: Total 10 bays		
8 front hot-swap 2.5" SATA drive bays		
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Orive Bays Configuration	Default: Total 8 bays • 8 front hot-swap 2.5" SATA drive bays
	Option A: Total 10 bays • 8 front hot-swap 2.5" SATA drive bays

• 2 front hot-swap 2.5" PCIe 5.0 x4 NVMe\* drive bays

Option B: Total 10 bays

- 4 front hot-swap 2.5" PCIe 5.0 x4 NVMe\* drive bays
- 6 front hot-swap 2.5" SATA drive bays

Option C: Total 10 bays

- 8 front hot-swap 2.5" PCIe 5.0 x4 NVMe\* drive bays
- 2 front hot-swap 2.5" SATA drive bays

Option D: Total 10 bays

• 10 front hot-swap 2.5" SAS\* drive bays

(\*NVMe/SAS support may require additional storage controller and/or cables, please see the optional parts list for

M.2: 2 M.2 PCIe 5.0 x2 NVMe slots (M-key 2280/22110; VROC required for RAID)

Expansion	Slots	Defaul

• 2 PCIe 5.0 x16 FHFL slots • 1 PCIe 5.0 x8 (in x16) LP slot

On-Board Devices SATA: SATA (6Gbps)

NVMe: NVMe; RAID 0/1/5/10 support(Intel® VROC RAID key required)

Chipset: System on Chip

Network Connectivity: 2 RJ45 1GbE with Intel® I210

Input / Output

LAN: 2 RJ45 1 GbE LAN ports

1 RJ45 1 GbE Dedicated BMC LAN port (IPMI shared on LAN port 1)

USB: 2 USB 3.2 Gen1 Type-A ports(rear) 2 USB 3.2 Gen1 Type-A ports(front) Video: 1 VGA port Serial: 1 COM port(Rear) 1 COM port(Header)

TPM: 1 TPM header



Chassis

(Front View - System)

Status LEDs

Power Button

UID Button

2 USB 3.2 Gen 1 Ports

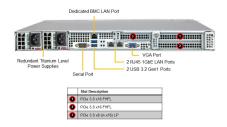
Dive Bay

Description

10 1661-8899 2.5° PCIs 5.0 10/046\*\* (Oxford Dive Bays)

CSE-116BTS-R000WNP

(Rear View - System)



Notherboard	Super X14SBW-F
	Non-operating Relative Humidity: 8% to 90% (non-condensing)
	Operating Relative Humidity: 8% to 80% (non-condensing)
	Non-operating Temperature: -30°C to 60°C (-22°F to 140°F)
Operating Environment	Operating Temperature: 10°C ~ 35°C (50°F ~ 95°F)
	Available Color: Black
	Net Weight: 21 lbs (9.53 kg)
Dimensions and Weight	Weight: Gross Weight: 33.5 lbs (15.2 kg)
	Thermal Control for fan connectors
	Temperature: Monitoring for CPU and chassis environment
	Pulse Width Modulated (PWM) fan connectors
	Status monitor for speed control
	FAN: Fans with tachometer monitoring
	8 Phase-switching voltage regulator
PC Health Monitoring	CPU: Monitors for CPU Cores, Chipset Voltages, Memory
	Agent Service (TAS); SuperServer Automation Assistant (SAA) New!
Management	SuperCloud Composer; Supermicro Server Manager (SSM); Super Diagnostics Offline (SDO); Supermicro Thin-
System BIOS	BIOS Type: AMI 64MB SPI Flash EEPROM
Power Supply	2x 860W Redundant (1 + 1) Titanium Level (96%) power supplies
Davier Cumple	2v 0COW Deduction to 11 + 1) Titanium Leval (0CO) in avvar avantica
	Air Shroud: 1 CPU Air Shroud
	5 middle cooling PWM 40x40x56mm Fan(s)
System Cooling	Fans: 1 AOC cooling Fan(s) (optional)